TOSHIBA Zener Diode Silicon Epitaxial Planar Type

# **MSZ Series**

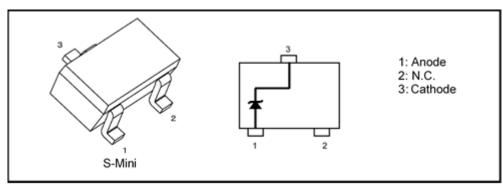
#### Applications

Voltage surge protection

#### Features

- Small package
- The typical voltage of Vz is accorded to E24 series

#### Packaging and Internal Circuit



#### Absolute Maximum Ratings 1 (Note) (Unless otherwise specified, Ta = 25°C)

Characteristics	Symbol	Rating	Unit
Power dissipation	PD	200	mW
	PD <sup>*1</sup>	600	mW
Junction temperature	Тј	150	°C
Storage temperature	T <sub>stg</sub>	-55 to 150	°C

#### Absolute Maximum Ratings 2 (Note) (Unless otherwise specified, Ta = 25°C)

Type No.	Electrostatic discharge voltage *2		Peak pulse Peak pulse		Type No.	Electrostatic discharge voltage *2		Peak pulse	Peak pulse
	Contact	Air	power <sup>*3</sup>	current <sup>*3</sup>		Contact	Air	power <sup>*3</sup>	current <sup>*3</sup>
	V <sub>ESD</sub> (kV)		P <sub>PK</sub> (W)	IPP(A)		V <sub>ESD</sub> (kV)		P <sub>PK</sub> (W)	I <sub>PP</sub> (A)
MSZ5V6	± 30		155	12	MSZ16V	± 30		200	5.5
MSZ6V2	± ;	30	175	11	MSZ20V	± 30		200	5
MSZ6V8	± 30		180	10	MSZ24V	± 30		200	4.5
MSZ8V2	±	30	200	8.5	MSZ30V	± 20		200	4
MSZ12V	± 30		200	7	MSZ36V	±	12	200	3

- Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc.).
- \*1: Mounted on a glass epoxy circuit board of 25.4 mm × 25.4 mm, Cu pad: 645 mm<sup>2</sup>
- \*2: according to IEC61000-4-2
- \*3: according to IEC61000-4-5, tp = 8 / 20  $\mu$ s

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#### MSZ series Electrical Characteristics (Unless otherwise specified, T<sub>a</sub> = 25°C)

Type No.	Zener Voltage			Dynamic Impedance		Dynamic resistance	Clamp voltage	Total capacitance	Reverse Current		
		V <sub>Z</sub> (V)		Test Current	Z <sub>Z</sub> (Ω)	Test Current I <sub>Z</sub> (mA)	$R_{DYN}(\Omega)^{*1}$	V <sub>C</sub> (V) <sup>*1*2</sup>	C <sub>t</sub> (pF) <sup>*3</sup>	I <sub>R</sub> (μA)	Test Voltage V <sub>R</sub> (V)
	Min	Тур.	Max	I <sub>Z</sub> (mA)	Max		Тур.	Тур.	Тур.	Max	
MSZ5V6	5.3	5.6	6.0	5	30	5	0.16	9	125	1	3.5
MSZ6V2	5.8	6.2	6.6	5	30	5	0.21	10	105	2.5	5.0
MSZ6V8	6.4	6.8	7.2	5	30	5	0.27	13	88	1.5	5.5
MSZ8V2	7.7	8.2	8.7	5	30	5	0.37	16.5	67	0.1	7
MSZ12V	11.4	12	12.6	5	30	5	0.7	26	44	0.1	10
MSZ16V	15.3	16	17.1	5	35	5	0.5	27	35	0.1	14
MSZ20V	18.8	20	21.2	5	70	5	0.35	30.5	29	0.1	17.6
MSZ24V	22.8	24	25.6	5	70	5	0.6	36.5	26	0.1	19
MSZ30V	28.0	30	32.0	2	100	2	1.25	47.5	21	0.1	27
MSZ36V	34.0	36	38.0	2	100	2	2.6	63	18	0.1	32.5

\*1: TLP parameters:  $Z_0 = 50 \ \Omega$ ,  $t_p = 100 \ ns$ ,  $t_r = 300 \ ps$ , averaging window:  $t_1 = 30 \ ns$  to  $t_2 = 60 \ ns$ ,

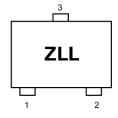
extraction of dynamic resistance using least squares fit of TLP characteristics between  $I_{TLP1} = 16$  A and  $I_{TLP2} = 30$  A. \*2:  $I_{TLP} = 16$  A

\*3: VR = 0 V, f = 1 MHz

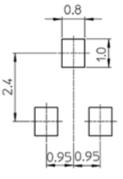
#### Marking List

Type No.	Marking	Type No.	Marking
MSZ5V6	ZLL	MSZ16V	ZM7
MSZ6V2	ZLM	MSZ20V	ZM9
MSZ6V8	ZLN	MSZ24V	ZMB
MSZ8V2	ZLQ	MSZ30V	ZMD
MSZ12V	ZM4	MSZ36V	ZMF

#### Marking (MSZ5V6)

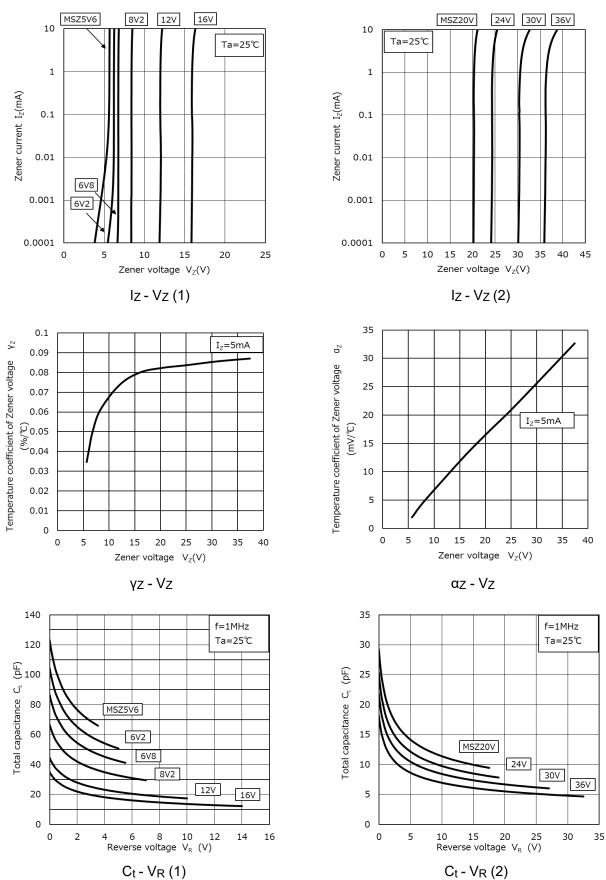


#### Land Pattern Dimensions (for reference only) (Unit: mm)



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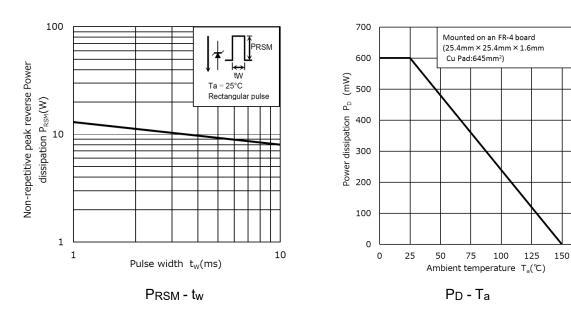
#### **MSZ** series Characteristics Curves (Note 1)

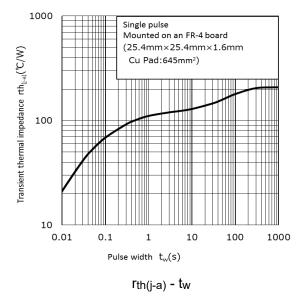


Note 1: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.

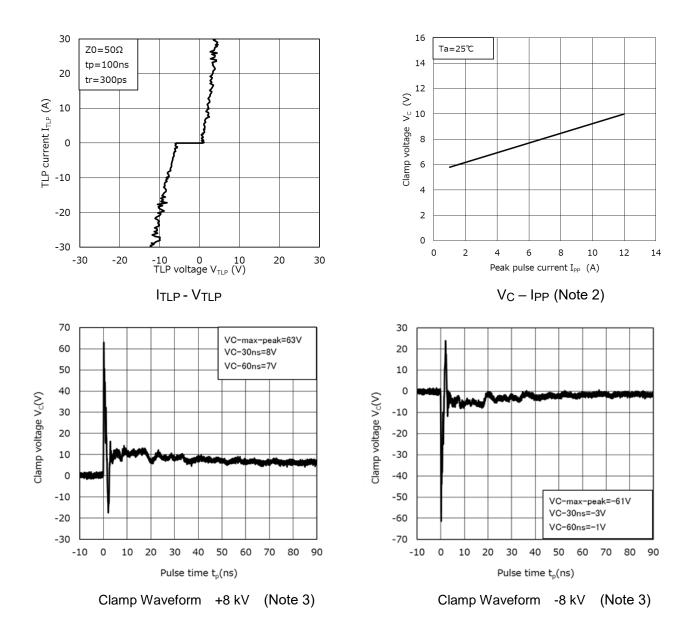
175

## **MSZ** series Characteristics Curves (Note 1)

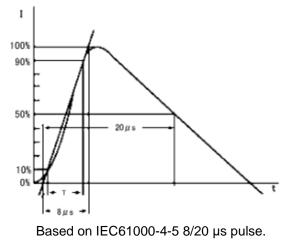




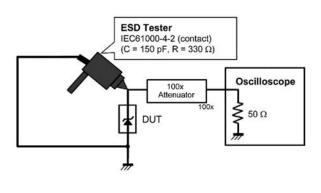
### MSZ5V6 Characteristics Curves (Note 1)

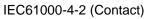




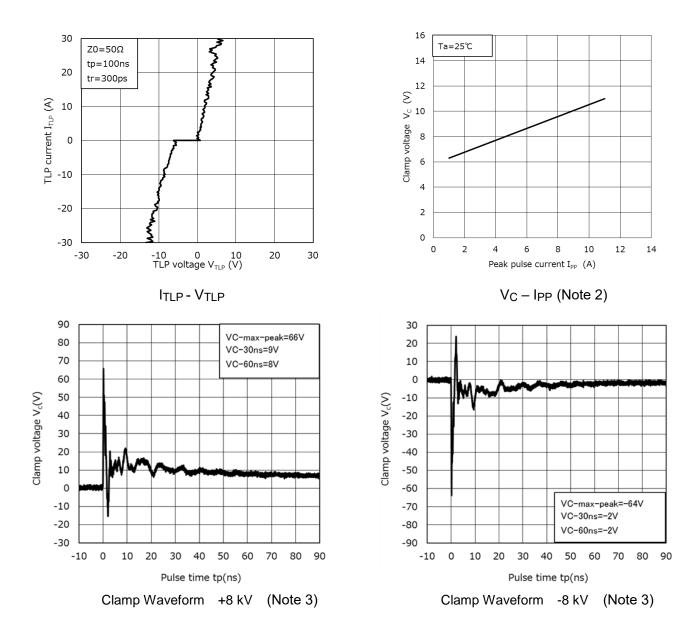




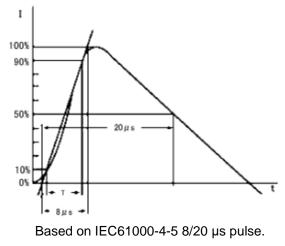




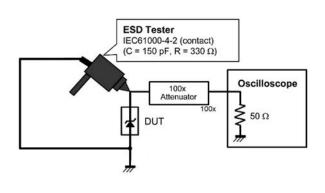
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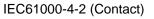


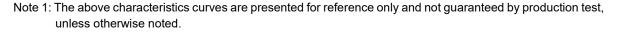




(Note 3) Clamp waveform measurement circuit

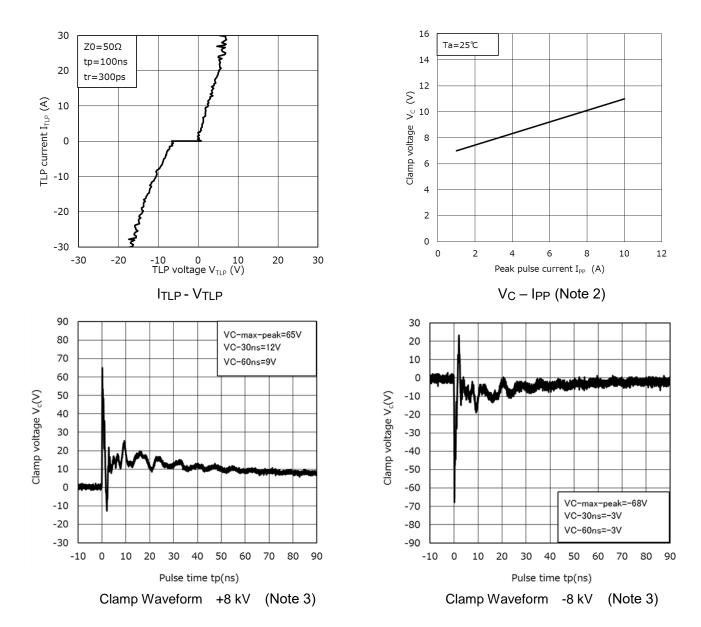




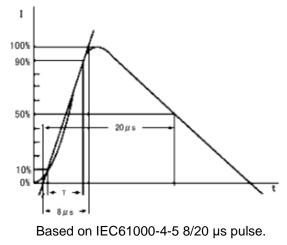


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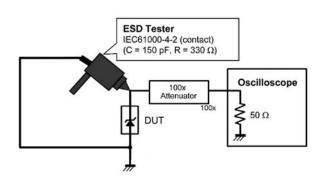
## MSZ6V8 Characteristics Curves (Note 1)

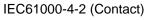


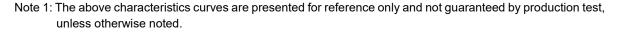




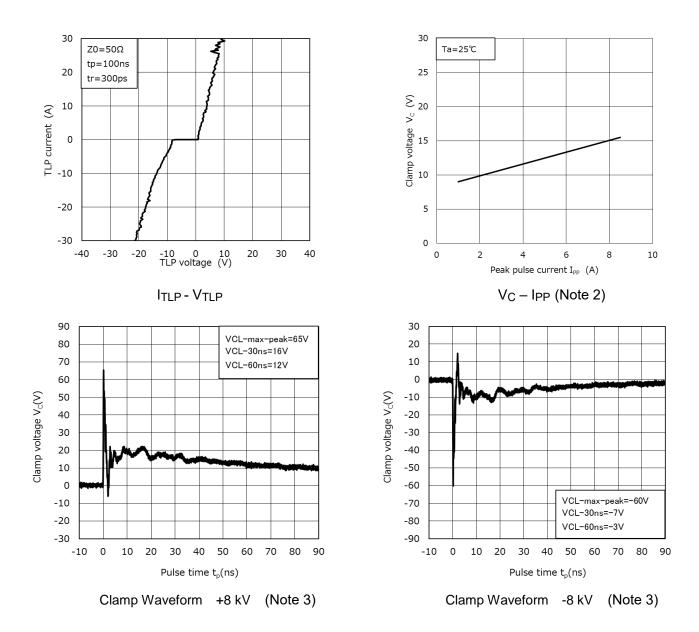
(Note 3) Clamp waveform measurement circuit



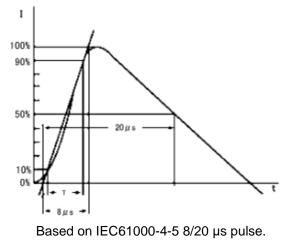




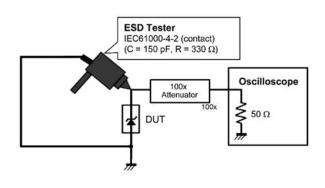
## MSZ8V2 Characteristics Curves (Note 1)





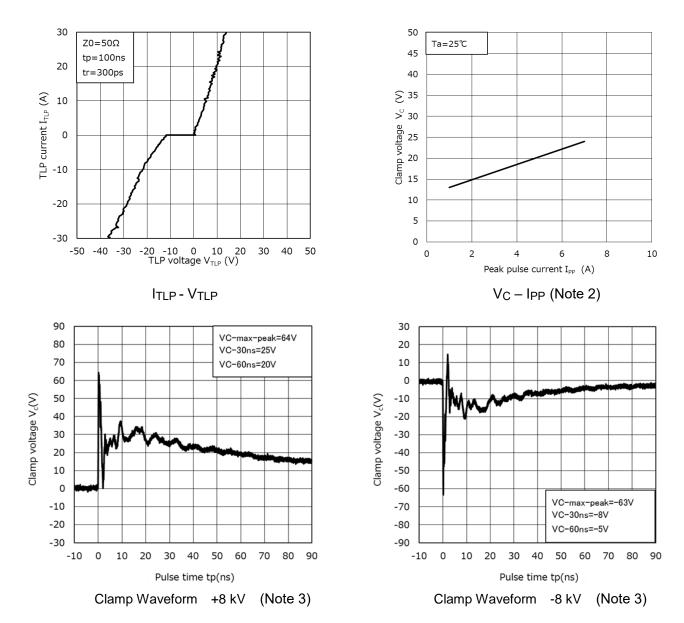


(Note 3) Clamp waveform measurement circuit

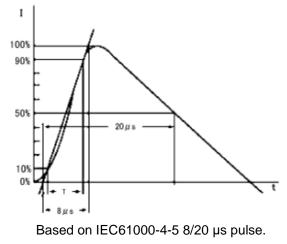


IEC61000-4-2 (Contact)

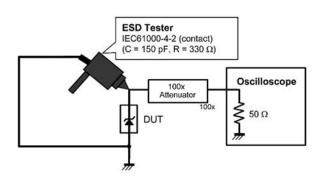
## **MSZ12V** Characteristics Curves (Note 1)





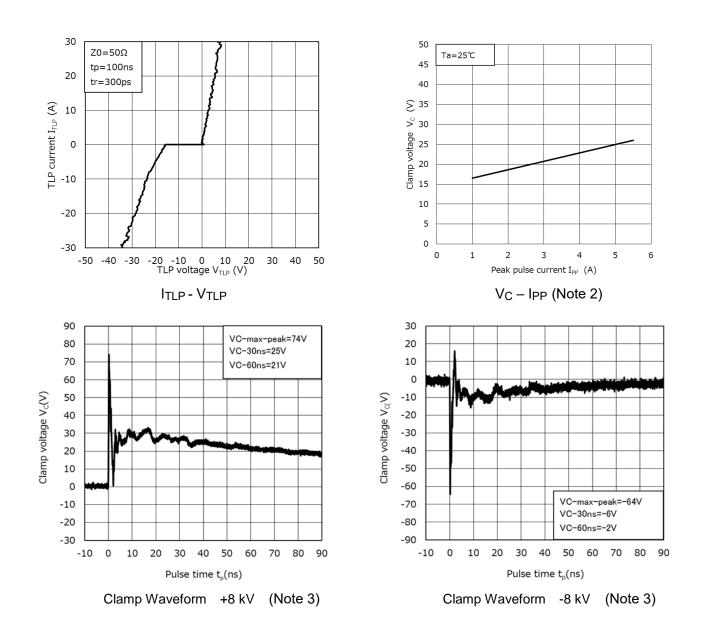


(Note 3) Clamp waveform measurement circuit

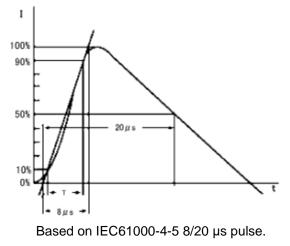


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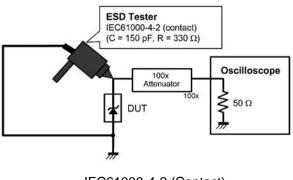
## **MSZ16V** Characteristics Curves (Note 1)

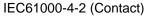




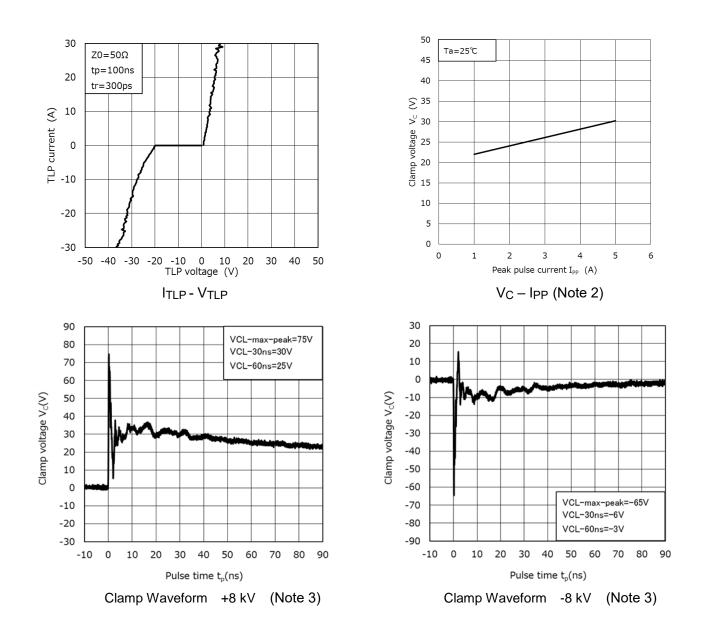


(Note 3) Clamp waveform measurement circuit

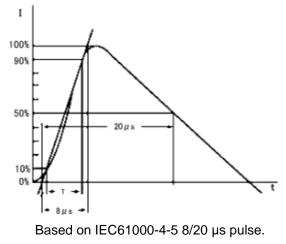




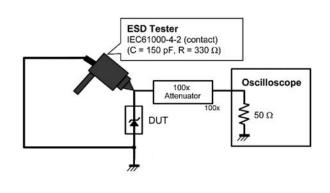
## **MSZ20V Characteristics Curves (Note 1)**

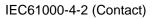




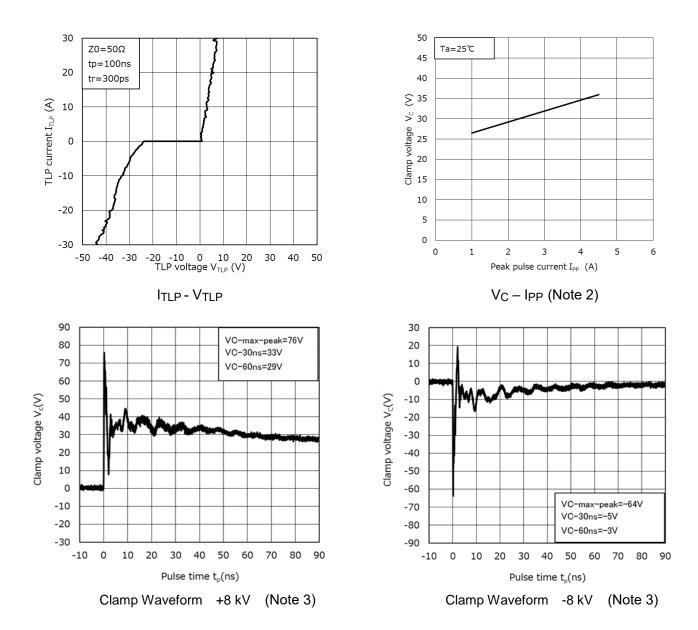


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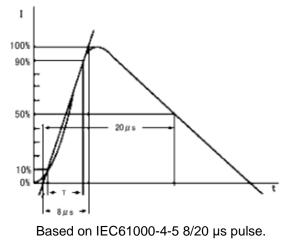




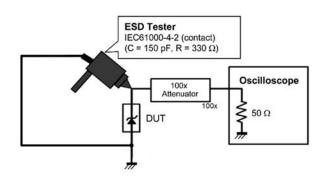
## **MSZ24V Characteristics Curves (Note 1)**

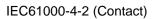




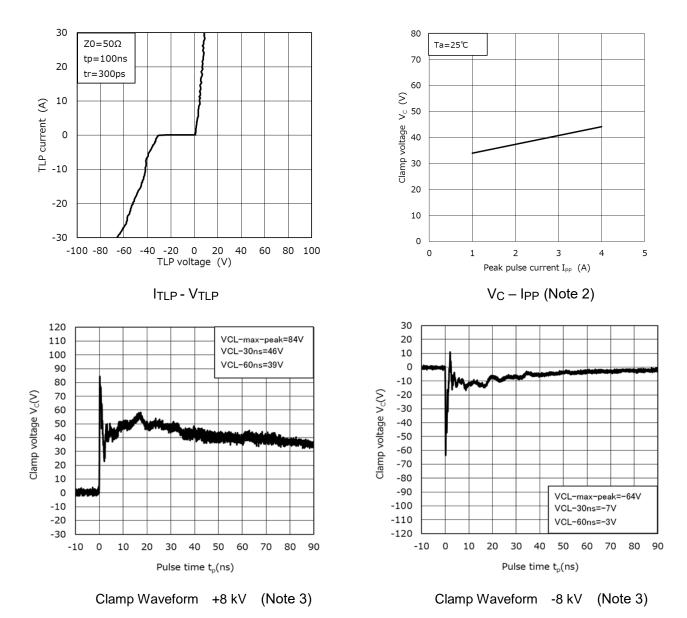


(Note 3) Clamp waveform measurement circuit

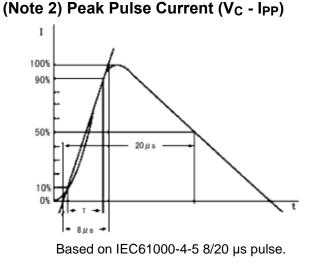




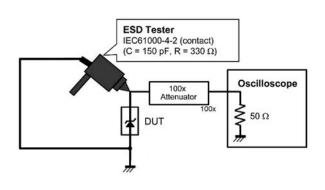
### **MSZ30V** Characteristics Curves (Note 1)

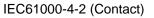




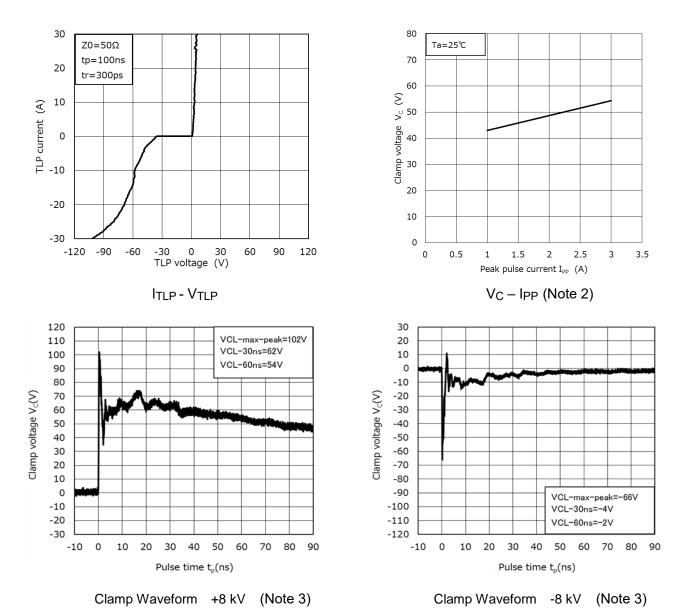


(Note 3) Clamp waveform measurement circuit



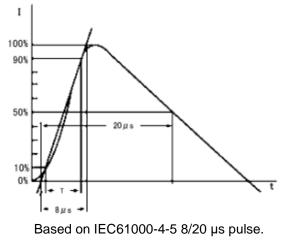


## MSZ36V Characteristics Curves (Note 1)

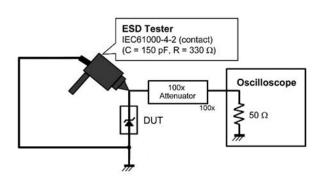








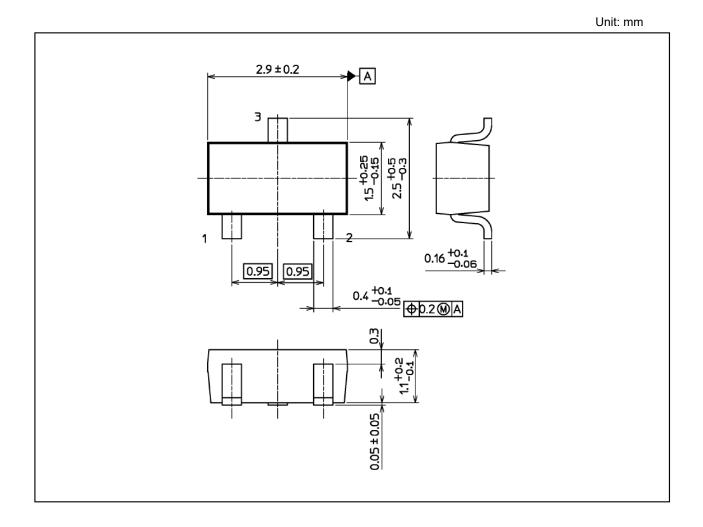
(Note 3) Clamp waveform measurement circuit



IEC61000-4-2 (Contact)



#### **Package Dimensions**



Weight: 12mg (typ.)

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